MOSFET - SiC Power, Single N-Channel, TO247-4L

1200 V, 160 mΩ, 17.3 A

NVH4L160N120SC1

Features

- Typ. $R_{DS(on)} = 160 \text{ m}\Omega$
- Ultra Low Gate Charge ($Q_{G(tot)} = 34 \text{ nC}$)
- High Speed Switching with Low Capacitance ($C_{oss} = 49.5 \text{ pF}$)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

Typical Applications

- Automotive On Board Charger
- Automotive DC/DC Converter for EV/HEV

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

-	-		,		
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	1200	V
Gate-to-Source Voltage	Gate-to-Source Voltage			-15/+25	V
Recommended Operation Values T _C < 175°C of Gate-to-Source Voltage		V _{GSop}	-5/+20	V	
Continuous Drain Current (Note 2)	Steady T _C = 25°C State		۱ _D	17.3	A
Power Dissipation (Note 2)			PD	111	W
Continuous Drain Current (Notes 1, 2)	Steady State	T _C = 100°C	۱ _D	12.3	A
Power Dissipation (Notes 1, 2)			P _D	55.5	W
Pulsed Drain Current (Note 3)	T _A = 25°C		I _{DM}	69	A
Single Pulse Surge Drain Current Capability	$\begin{array}{l} T_{A}=25^{\circ}C,t_{p}=10\;\mu s,\\ R_{G}=4.7\;\Omega \end{array}$		I _{DSC}	140	A
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			I _S	11	А
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 16 A, L = 5 mH$) (Note 4)			E _{AS}	128	mJ
Maximum Lead Temperature for Soldering (1/8" from case for 5 s)			ΤL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

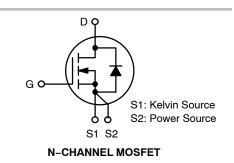
- JA is constant value to follow guide table of LV/HV discrete final datasheet generation.
 The entire application environment impacts the thermal resistance values shown,
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
 Repetitive rating, limited by max junction temperature.
- 4. EAS of 128 mJ is based on starting $T_J = 25^{\circ}C$; L = 5 mH, $I_{AS} = 16$ A, $V_{DD} = 120$ V, $V_{GS} = 18$ V.



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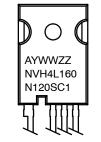
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
1200 V	224 mΩ @ 20 V	17.3 A





MARKING DIAGRAM



A = Assembly Location

Y = Year

WW = Work Week

ZZ = Lot Traceability

NVH4L160N120SC1 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
NVH4L160N120SC1	TO247-4L	30 ea / Tube

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	1.35	°C/W
Junction-to-Ambient - Steady State (Notes 1, 2)	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

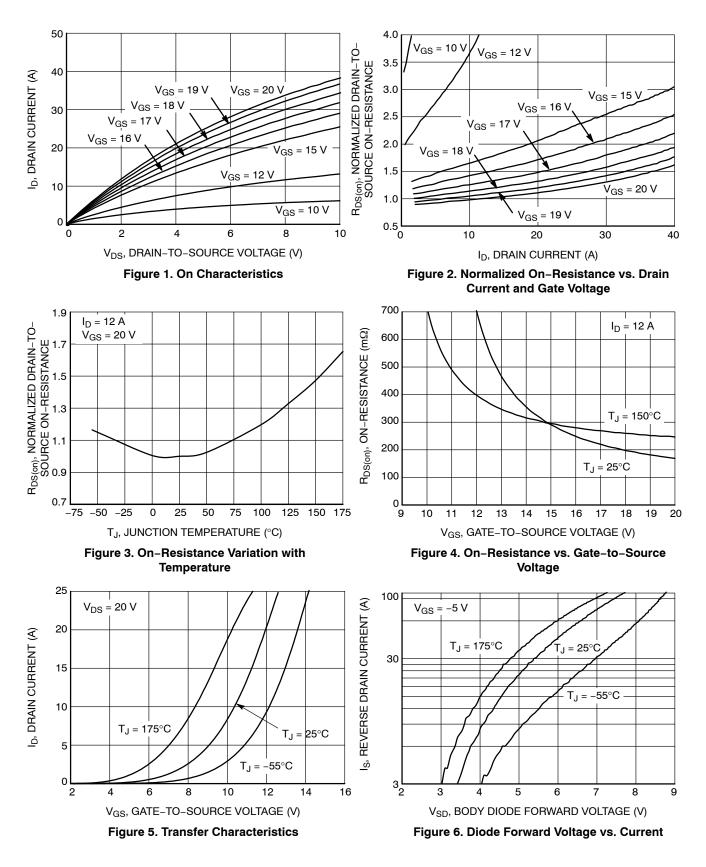
Parameter	Symbol	Test Condi	tion	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 mA		1200	_	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 1 \text{ mA}$, referenced to 25°C		-	0.6	-	V/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$	-	-	100	μA
		V _{DS} = 1200 V	T _J = 175°C	-	-	1	mA
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = +25/-15 \text{ V}, \text{ V}_{D}$	_{os} = 0 V	-	-	±1	μA
ON CHARACTERISTICS (Note 3)					-	-	-
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 2.5 m	nA	1.8	3.1	4.3	V
Recommended Gate Voltage	V _{GOP}			-5	-	+20	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 20 V, I _D = 12 A	, T _J = 25°C	-	160	224	mΩ
		V _{GS} = 20 V, I _D = 12 A	, T _J = 175°C	-	271	377	
Forward Transconductance	9 _{FS}	V _{DS} = 20 V, I _D = 12 A		-	3.2	-	S
CHARGES, CAPACITANCES & GATE RES	SISTANCE						
Input Capacitance	C _{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 800 V		-	665	-	pF
Output Capacitance	C _{OSS}			_	49.5	-	
Reverse Transfer Capacitance	C _{RSS}			_	4.3	-	
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -5/20 \text{ V}, V_{DS} = 600 \text{ V},$ $I_D = 16 \text{ A}$ f = 1 MHz		_	34	-	nC
Threshold Gate Charge	Q _{G(TH)}			-	6	-	-
Gate-to-Source Charge	Q _{GS}			-	12.5	-	
Gate-to-Drain Charge	Q _{GD}			_	9.6	-	
Gate-Resistance	R _G			-	1.4	-	Ω
SWITCHING CHARACTERISTICS, VGS =	10 V				1	1	
Turn–On Delay Time	t _{d(ON)}	$V_{GS} = -5/20 V,$		-	11	20	ns
Rise Time	t _r	V _{DS} = 800 V, I _D = 16 A,		-	10	20	
Turn-Off Delay Time	t _{d(OFF)}	$R_{G} = 6 \Omega$		-	14	25	1
Fall Time	t _f	Inductive IDau	inductive load		7	14	
Turn-On Switching Loss	E _{ON}			-	104	-	μJ
Turn-Off Switching Loss	E _{OFF}			-	32	-	
Total Switching Loss	E _{tot}			-	136	-	
DRAIN-SOURCE DIODE CHARACTERIST		I			1	11	
Continuous Drain-Source Diode Forward Current	I _{SD}	$V_{GS} = -5 \text{ V}, \text{ T}_{\text{J}} = 25^{\circ} \text{ (}$	0	-	-	11	A
Pulsed Drain-Source Diode Forward Current (Note 3)	I _{SDM}			-	-	69	
Forward Diode Voltage	V _{SD}	V _{GS} = –5 V, I _{SD} = 6 A, T _J = 25°C		_	4	_	V

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified) (continued)

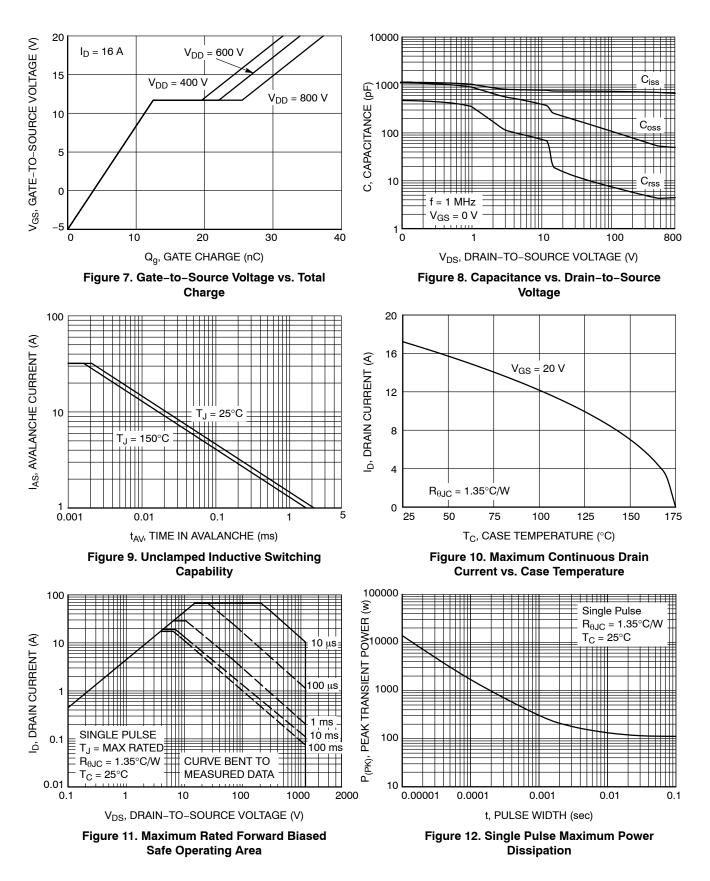
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS							
Reverse Recovery Time	t _{RR}	V _{GS} = -5/20 V, I _{SD} = 16 A, dI _S /dt = 1000 A/μs	-	15	-	ns	
Reverse Recovery Charge	Q _{RR}	αι _S /αt = 1000 Α/μs	-	47	-	nC	
Reverse Recovery Energy	E _{REC}		-	3.9	-	μJ	
Peak Reverse Recovery Current	I _{RRM}		-	6.6	-	А	
Charge time	Ta		-	7.0	-	ns	
Discharge time	Tb]	-	7.4	-	ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

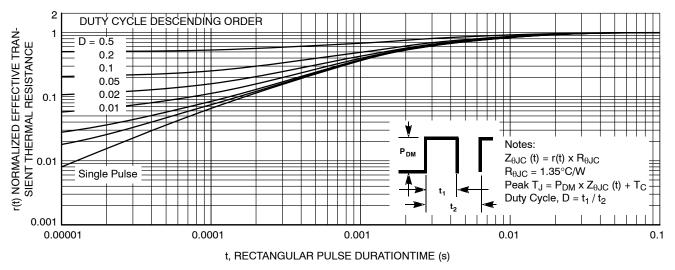
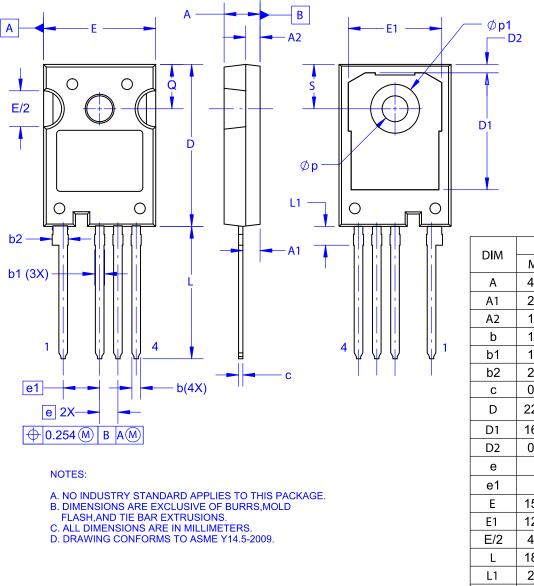


Figure 13. Junction-to-Case Transient Thermal Response Curve



TO-247-4LD CASE 340CJ ISSUE A

DATE 16 SEP 2019



	MILLIMETERS				
DIM	MIN	NOM	MAX		
А	4.80	5.00	5.20		
A1	2.10	2.40	2.70		
A2	1.80	2.00	2.20		
b	1.07	1.20	1.33		
b1	1.20	1.40	1.60		
b2	2.02	2.22	2.42		
С	0.50	0.60	0.70		
D	22.34	22.54	22.74		
D1	16.00	16.25	16.50		
D2	0.97	1.17	1.37		
е	2.54 BSC				
e1	Ę	5.08 BSC	2		
Е	15.40	15.60	15.80		
E1	12.80	13.00	13.20		
E/2	4.80	5.00	5.20		
L	18.22	18.42	18.62		
L1	2.42	2.62	2.82		
р	3.40	3.60	3.80		
p1	6.60	6.80	7.00		
Q	5.97	6.17	6.37		
S	5.97	6.17	6.37		

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